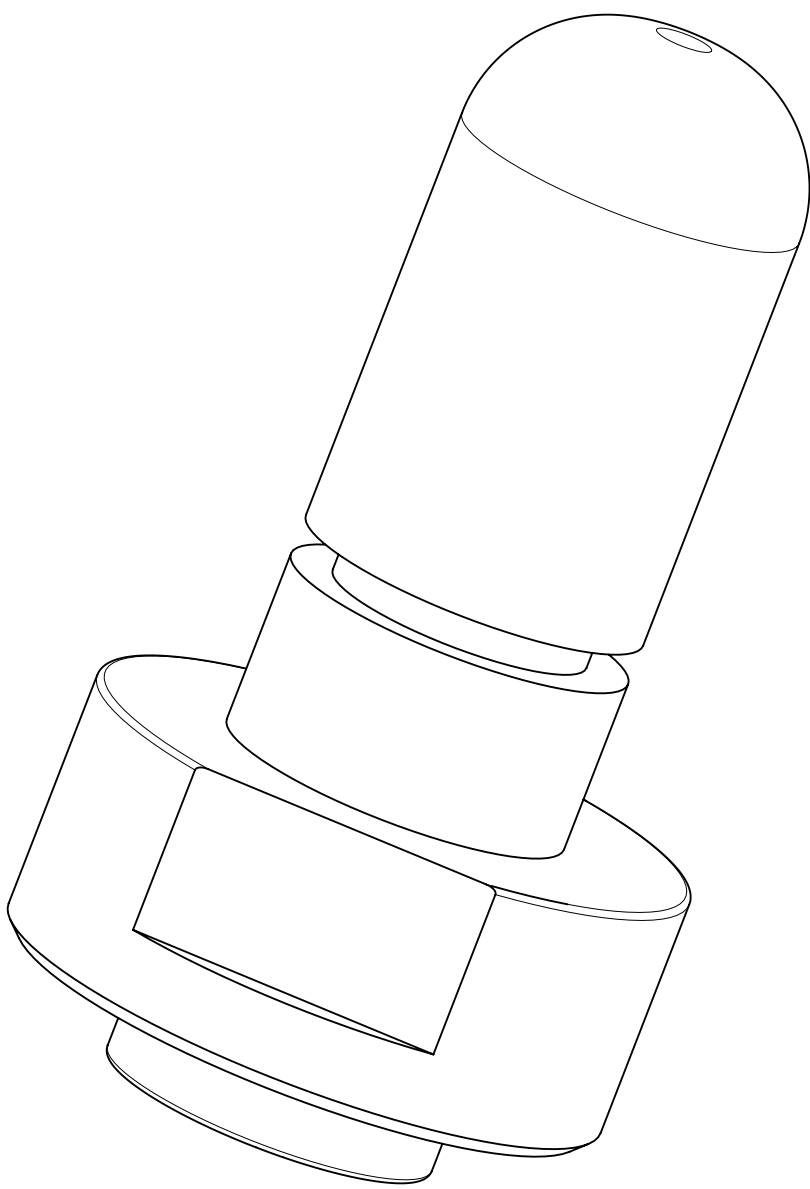
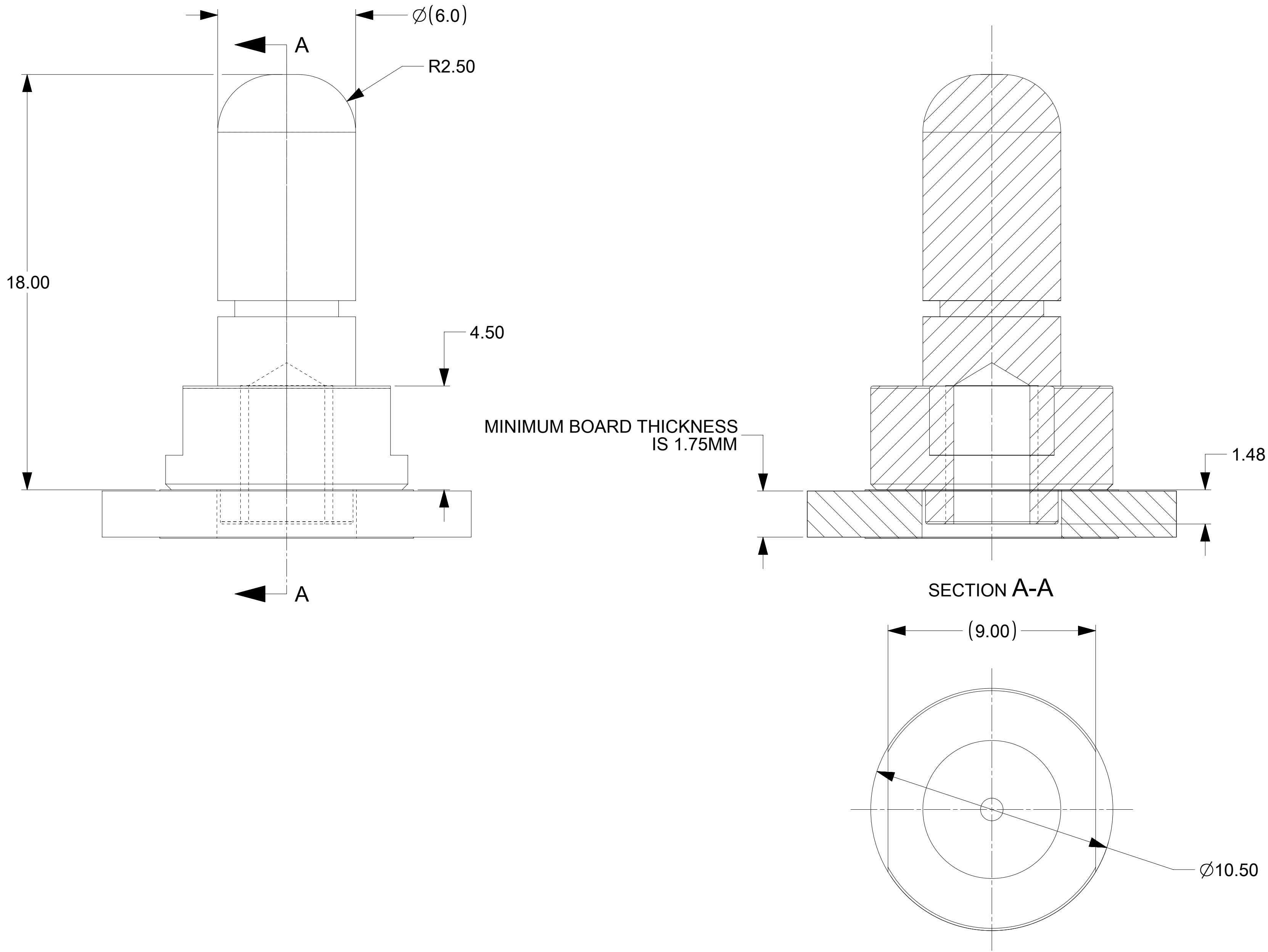
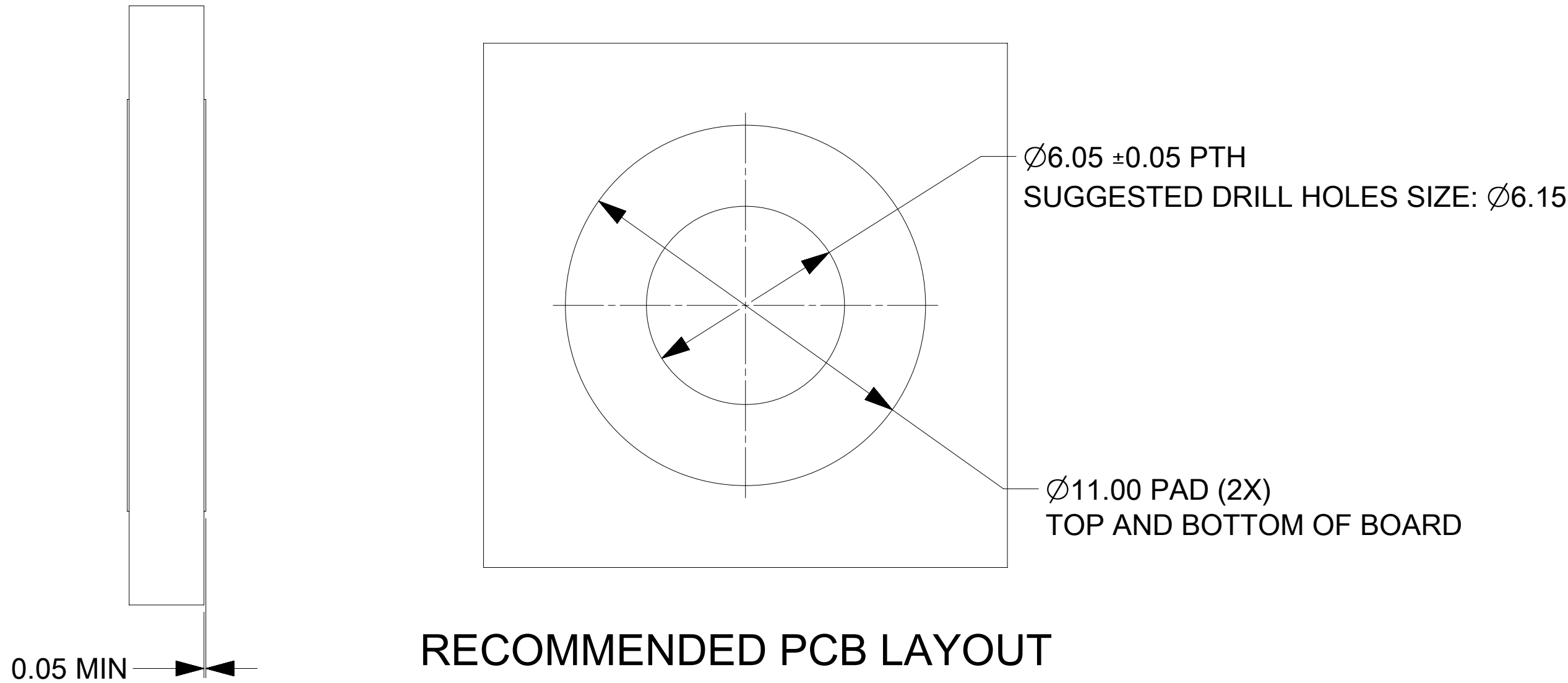




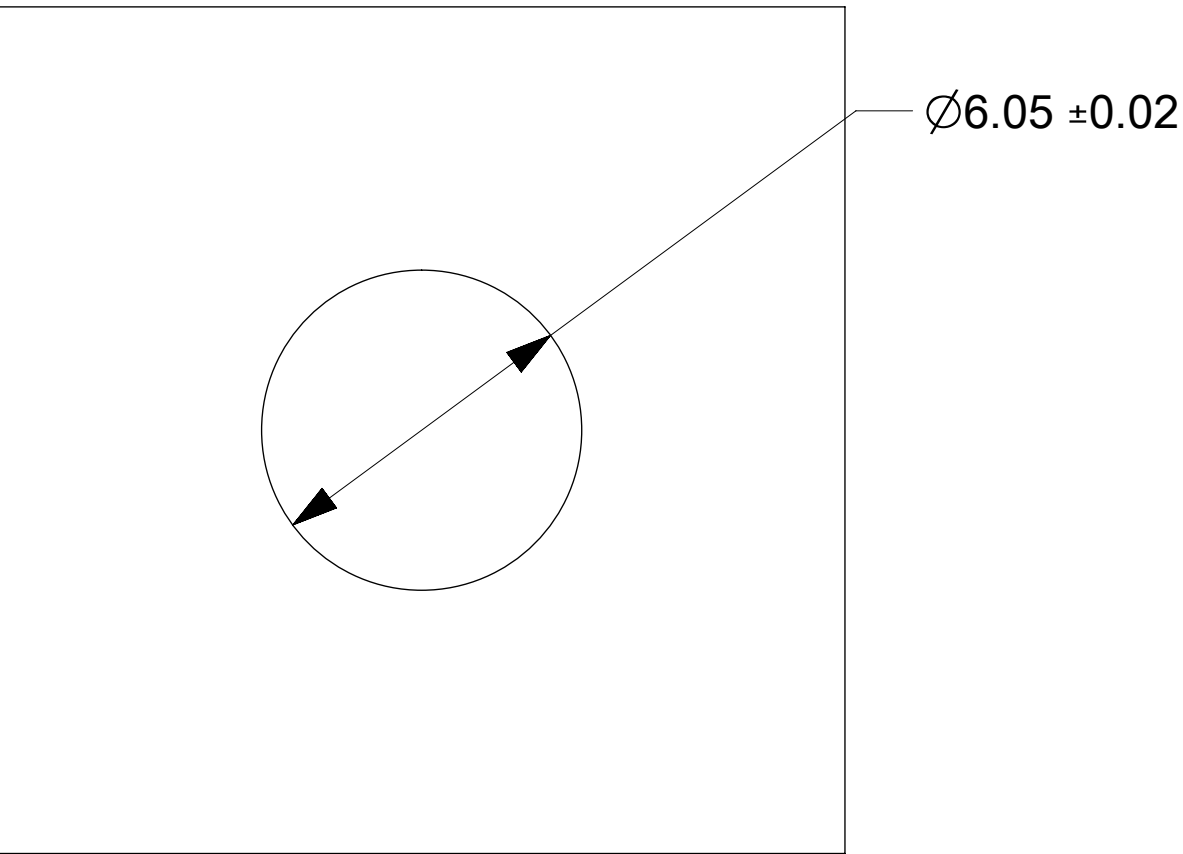
NOTES:

1. MATERIALS:
BASE METAL: HIGH CONDUCTIVE COPPER ALLOY
PLATING ON BODY: 3.18 MICRON MIN SILVER OVER 1.27 MICRON MIN NICKEL
2. SILVER COMPONENTS WILL BE SUPPLIED TARNISH FREE
BUT MAY TARNISH OVER TIME.
3. PART TO BE MOUNTED WITH CONDUCTIVE M4 SCREW AND
CONDUCTIVE BELLEVILLE WASHER FOR OPTIMAL PERFORMANCE
4. SCREW LENGTH TO BE DETERMINED BY CUSTOMER
BASED ON THE PCB/BUS BAR THICKNESS,
SCREWS AND WASHERS ARE NOT SUPPLIED BY MOLEX.
5. PRODUCT SPECIFICATION: 2178840001-PS
6. APPLICATION SPECIFICATION: 2178840001-AS
7. PACKAGING SPECIFICATION: BULK PACKAGING AS PER 2183350001-PK

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
DIMENSION UNITS	SCALE	CURRENT REV DESC: PRODUCT RELEASE							
mm	2:1								
GENERAL TOLERANCES (UNLESS SPECIFIED)									
ANGULAR TOL	± 0.5°								
4 PLACES	±								
3 PLACES	±								
2 PLACES	± 0.15								
1 PLACE	± 0.25								
0 PLACES	±								
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION	DRAWING	SERIES					
				D-SIZE	218371	MATERIAL NUMBER		CUSTOMER	
						2183710001		GENERAL MARKET	
								SHEET NUMBER	
								1 OF 1	



RECOMMENDED PCB LAYOUT



RECOMMENDED BUS BAR